HDI MICROVIA

HDI Microvia Standard Design Rules

Microvia Standard and copper filled

Filled & Capped Via and Microvia

PTH and Via filled & capped (IPC-4761, Type VII)

BGA 0.80 mm pitch

BGA 0.50 mm pitch

BGA 0.40 mm pitch

Which base material qualities are used in a PCB can be seen from the stackup. Würth Elektronik offers cost- and production-optimised standard stackups on its website. Here you can also find all standards as digital stackup files for import into your EDA software.

Do you have questions about fabrication data, tolerances, test documentation or packaging? In our Technical Delivery Specification for printed circuit boards (TDS) you will find our standards and recommendations for smooth and effective cooperation.

www.we-online.com/hdi-stackups

www.we-online.com/tds